



100V N-Channel Trench Power MOSFET

General Description

The SJZ017N12 uses SGT technology to provide excellent $R_{DS(on)}$, low gate charge and fast switching characteristics. This device is suitable for use as a wide variety of applications.

Features

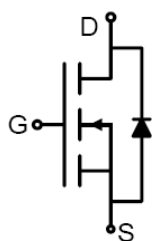
- Low Gate Charge
- 100% UIS Tested, 100% DVDS Tested
- High Power and current handling capability
- Lead free product is acquired

Application

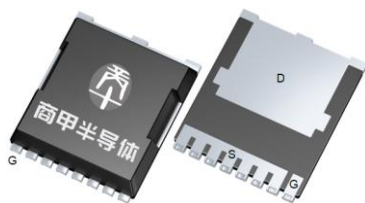
- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

Key Performance Parametes

Parameter	Value	Unit
V_{DS}	120	V
$R_{DS(ON_TYP)}$	1.8	m Ω
I_D	242	A
Q_G	204	nC



Schematic Diagram



TOLL top&bottom view



Package Marking and Ordering Information

Device/Ordering Code	Marking	Package	Packing	Reel Size	Tape width	Quantity
SJZ017N12	SJZ017N12	TOLL	Tube	\	\	1000 Pcs

Table 1. Absolute Maximum Ratings ($T_C=25^{\circ}\text{C}$ unless otherwise noted)

Symbol	Parameter	Limit	Unit
V_{DS}	Drain-Source Voltage ($V_{GS}=0\text{V}$)	120	V
V_{GS}	Gate-Source Voltage ($V_{DS}=0\text{V}$)	± 20	V
I_D	Drain Current-Continuous($T_C=25^{\circ}\text{C}$)	242	A
	Drain Current-Continuous($T_C=100^{\circ}\text{C}$)	153	A
$I_{DM}(\text{pluse})$	Drain Current-Continuous@ Current-Pulsed (Note 1)	968	A
P_D	Maximum Power Dissipation($T_C=25^{\circ}\text{C}$)	278	W
	Maximum Power Dissipation($T_C=100^{\circ}\text{C}$)	111	W
E_{AS}	Avalanche energy (Note 2)	2500	mJ
T_J, T_{STG}	Operating Junction and Storage Temperature Range	-55 To 150	$^{\circ}\text{C}$

Table 2. Thermal Characteristic

Symbol	Parameter	Typ	Max	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		0.45	$^{\circ}\text{C/W}$



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Table 3. Electrical Characteristics ($T_J=25^{\circ}\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
On/Off States						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V I _D =250μA	120			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =120V, V _{GS} =0V T _J =25℃			1	μA
		V _{DS} =120V, V _{GS} =0V T _J =125℃			100	μA
I _{GSS}	Gate-Body Leakage Current	V _{GS} =±20V, V _{DS} =0V			±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250μA	2		4	V
g _{FS}	Forward Transconductance	V _{DS} =10V, I _D =20A		46		S
R _{DS(ON)}	Drain-Source On-State Resistance	V _{GS} =10V, I _D =20A T _J =25℃		1.8	2.2	mΩ
Dynamic Characteristics						
C _{iss}	Input Capacitance	V _{DS} =60V, V _{GS} =0V, f=1.0MHz		9860		pF
C _{oss}	Output Capacitance			2570		pF
C _{rss}	Reverse Transfer Capacitance			50		pF
R _g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1.0MHz		0.6		Ω
Switching Parameters						
t _{d(on)}	Turn-on Delay Time	V _{GS} =10V, V _{DS} =60V, R _L =3Ω, R _{GEN} =6Ω		40		nS
t _r	Turn-on Rise Time			100		nS
t _{d(off)}	Turn-Off Delay Time			140		nS
t _f	Turn-Off Fall Time			108		nS
Q _g	Total Gate Charge	V _{GS} =10V, V _{DS} =60V, I _D =20A		204		nC
Q _{gs}	Gate-Source Charge			60		nC
Q _{gd}	Gate-Drain Charge			50		nC
Source-Drain Diode Characteristics						
I _{SD}	Source-Drain Current (Body Diode)				242	A
V _{SD}	Forward on Voltage (Note 3)	V _{GS} =0V, I _S =20A			1.2	V
t _{rr}	Reverse Recovery Time	I _F =20A, dI/dt=500A/μs		55		ns
Q _{rr}	Reverse Recovery Charge	I _F =20A, dI/dt=500A/μs		333		nC

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

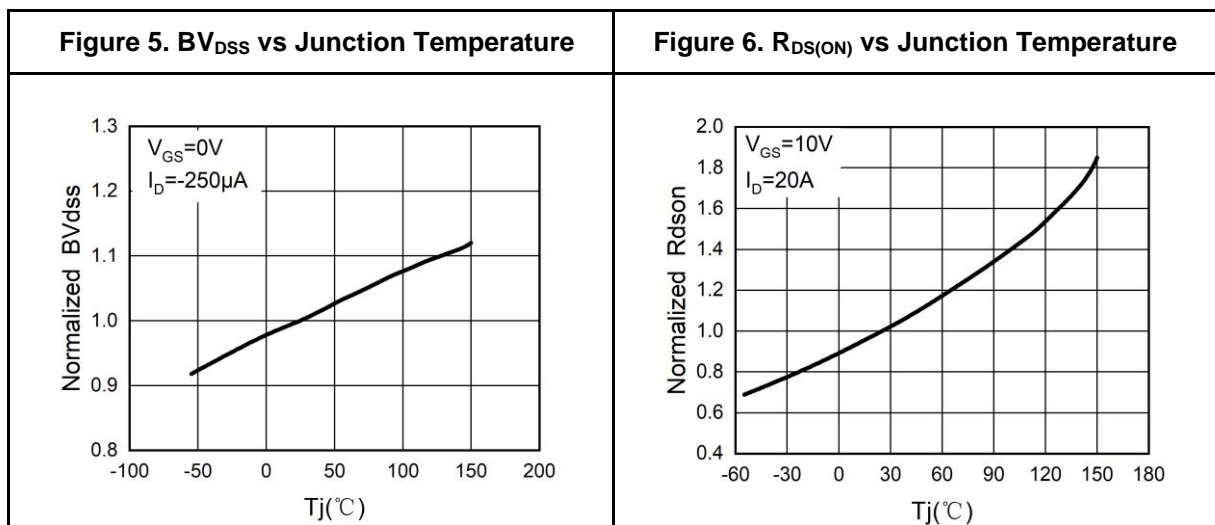
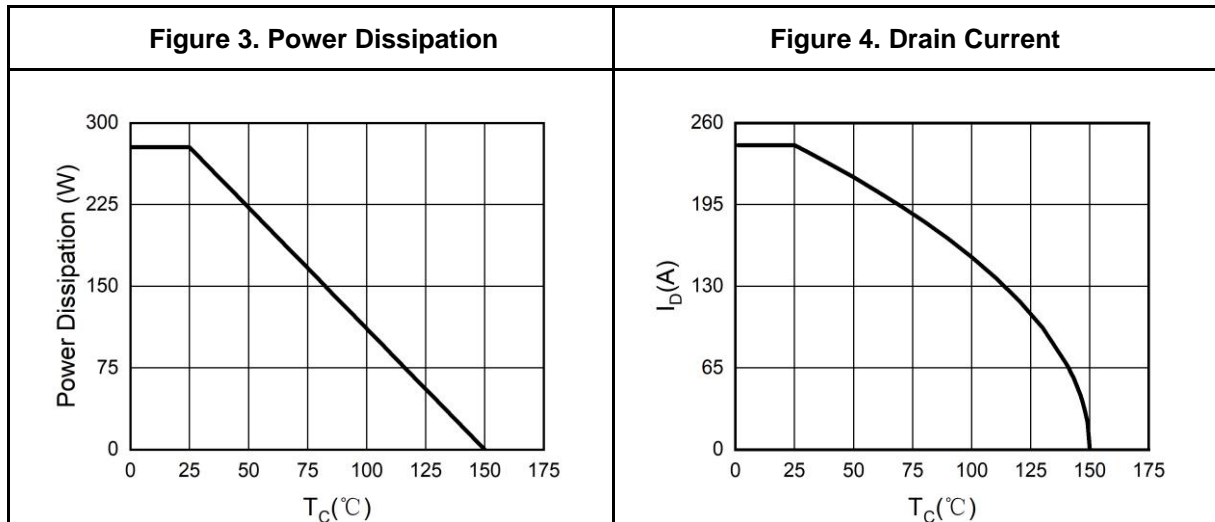
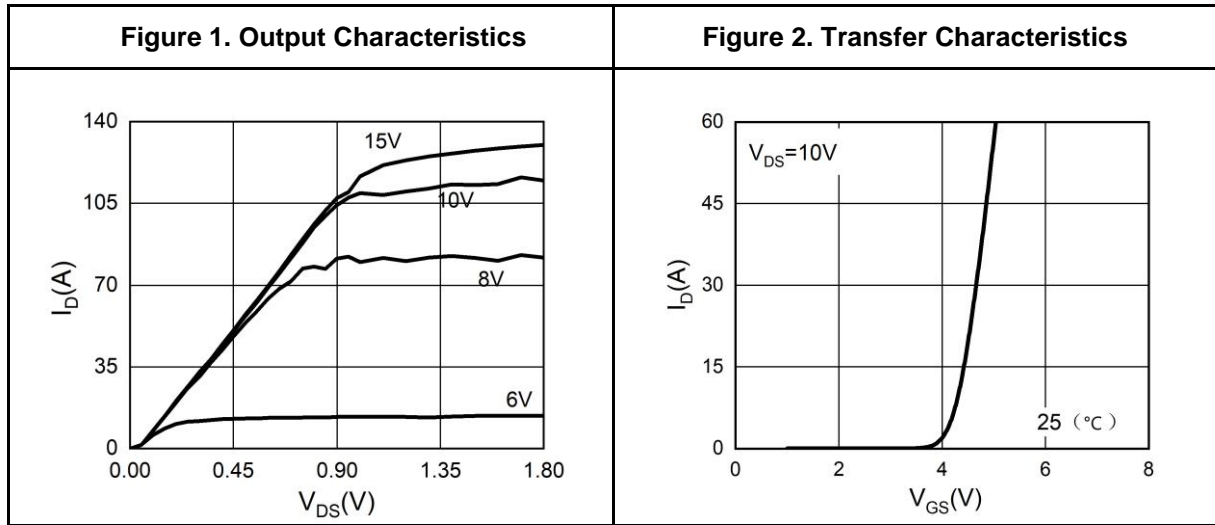
Notes 2.EAS condition: $T_J=25^{\circ}\text{C}, V_{DD}=50V, V_G=10V, R_g=25\Omega, L=0.5mH$.

Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.



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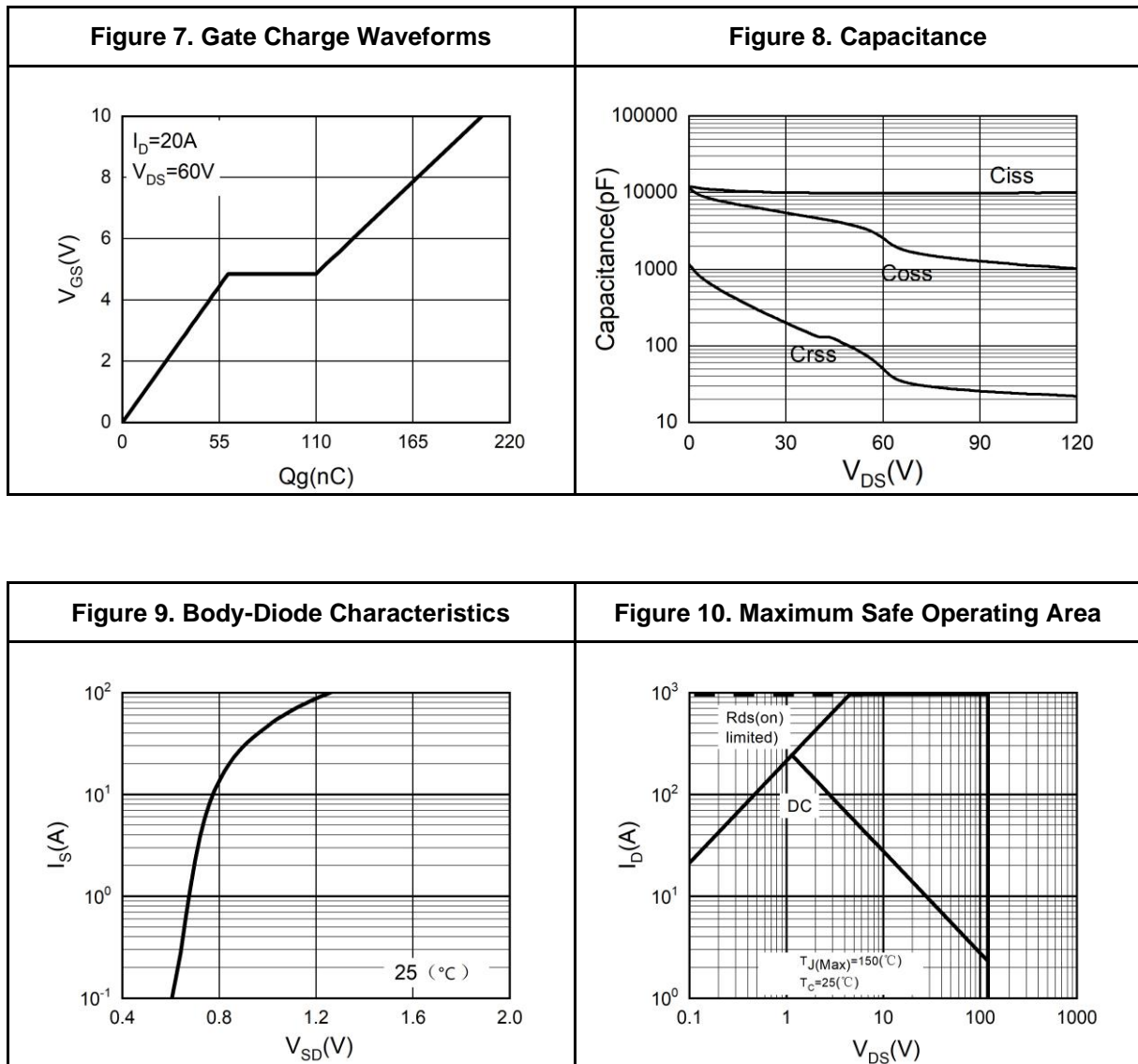
Typical Electrical And Thermal Characteristics (Curves)





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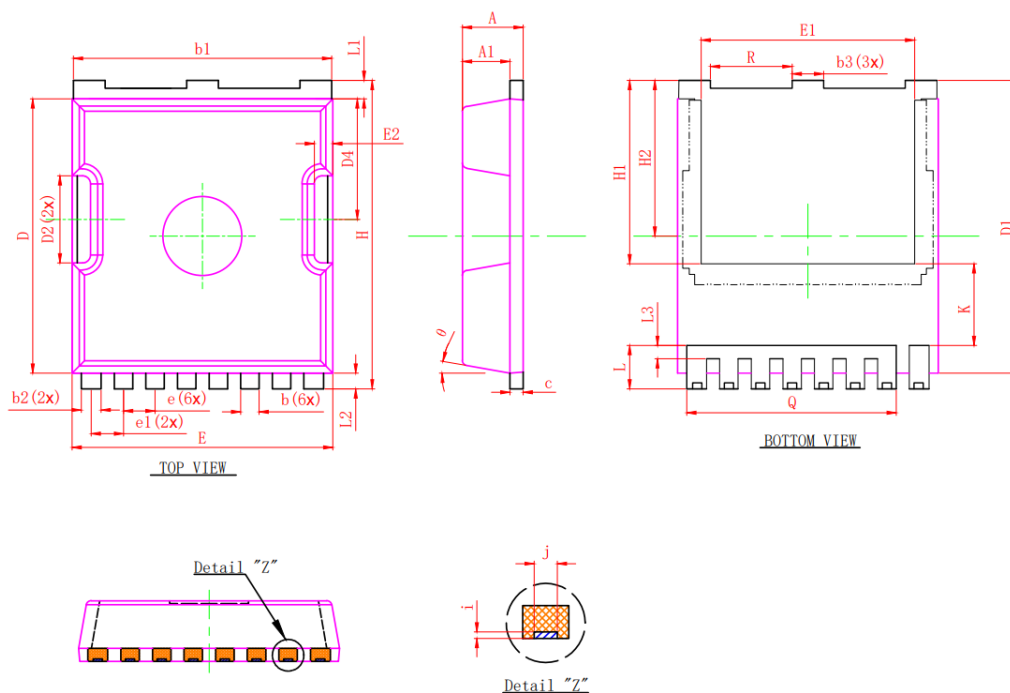
Typical Electrical And Thermal Characteristics (Curves)





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TOLL Package Information



SYMBOL	MILLIMETER		
	MIN.	NOM.	MAX.
A	2.200	2.300	2.400
A1	1.700	1.800	1.900
b	0.600	0.700	0.800
b1	9.700	9.800	9.900
b2	0.650	0.750	0.850
b3	1.100	1.200	1.300
c	0.400	0.500	0.600
D	10.300	10.400	10.500
D1	11.000	11.100	11.200
D2	3.200	3.300	3.400
D4	4.470	4.570	4.670
E	9.800	9.900	10.000
E1	8.000	8.100	8.200
E2	0.500	0.600	0.700
e	1.200 BSC		
e1	1.225 BSC		
H	11.600	11.700	11.800
H1	6.950 BSC		
H2	5.900 BSC		
i	0.100 REF.		
j	0.350 REF.		
K	3.100 REF.		
L	1.550	1.650	1.750
L1	0.600	0.700	0.800
L2	0.500	0.600	0.700
L3	0.400	0.500	0.600
Q	7.950 REF.		
R	3.000	3.100	3.200
θ	10° REF.		



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